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FAX RECEIVED**AUG 12 1998****GROUP 1700****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

KENICHI NAKAMURA

Serial No. 08/884,778

Filed: June 30, 1997

For: **BIODEGRADABLE MOLDING
MATERIAL**

Group Art Unit: 1755

Examiner: M. Marcheschi

AMENDMENTHon. Commissioner of Patents and Trademarks
Washington, D.C. 20231

Dear Sir:

In response to the Office Action dated May 20, 1998, please amend the above-
identified application as follows:

IN THE CLAIMS:

Claim 2, line 2, change "of" to --less than--;

line 3, delete "pass".

IN THE SPECIFICATION:

Page 5, line 4, change "BDT's" to --BDP's--.

Page 7, line 7, change "EcoPLA" to --ECOPLA--.

REMARKS

Applicant has amended the Claim 2 and the specification. Accordingly, the
Office Action will be discussed in terms of the claims and specification as amended.